

## **User's Guide**

## NHD-C12864CZ-FSW-GBW

LCM (Liquid Crystal Display Graphic Module)

## **COG- RoHS Compliant**

**NHD-** Newhaven Display

**12864-** 128 Lines x 64 Characters

CZ- Version LineF- Transflective

**SW-** Side White LED B/L

**G-** STN- Gray **B-** 6:00 View

W- Wide Temperature  $(-20 \sim +70c)$ 

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### **DOCUMENT REVISION HISTORY**

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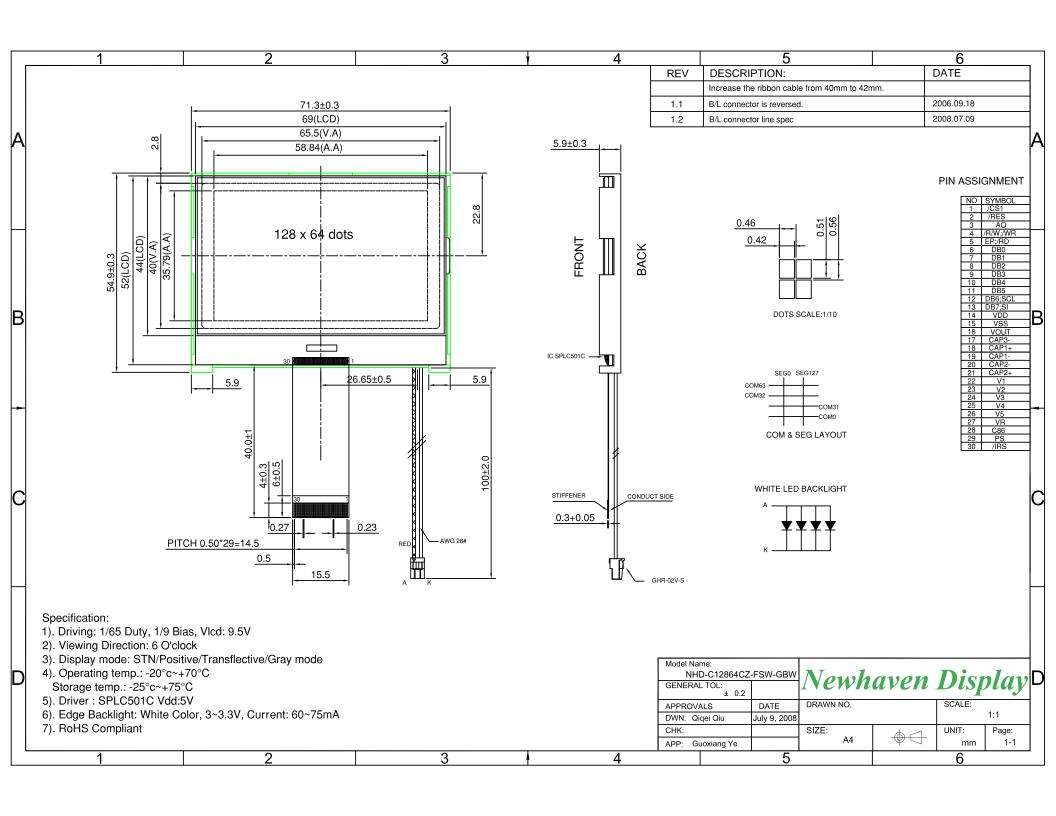
#### 1.Features

- 1. 128X64 dots
- 2. Built-in controller (SPLC501C)
- 3. +5.0V power supply4. 1/64 duty cycle;1/9bias
- 5. BKL to be driven by A, K.

LCD type	□FSTN positiv	е		□FSTN Negative		
	□STN Yellow Green		⊠STN	Gray	□STN-Blue	
View direction	☑6 O'clock		□12 C	)'clock		
Rear Polarizer	□Reflective		⊠Tran	sflective	□Transmissive	
Backlight Type	☑LED			□Internal Power	□4.2V input	
		□CCFL	_	☑External Power	☑3.0 input	
Backlight Color	□Yellow □Ambe		er □Blue-Green		☑White	
_	Green					
Temperature Range	☑Normal		□Wide		☐Super Wide	
DC to DC circuit	☑Build-in			□Not Build-in		
El Driver IC	□Build-in			☑Not Build-in		
Touch screen	☑With			□Without		
Font type	□English-Jap	lish-Jap □Englis		□English-Russian	☑other	
	anese	open				

#### 2. MECHANICAL SPECIFICATIONS

Module size	71.3mm(L)*54.9mm(W)* Max5.9(H)mm
Viewing area	65.5mm(L)*40.0mm(W)
Dots size	0.42mm(L)*0.51mm(W)
Dots pitch	0.46mm(L)*0.56mm(W)
Weight	Approx.



4.Absolute maximum ratings

Item	Symbol		Standard		Unit
Power voltage	V <sub>DD</sub> -V <sub>SS</sub>	0	-	7.0	\/
Input voltage	V <sub>IN</sub>	VSS	-	VDD	V
Operating temperature range	V <sub>OP</sub>	-20	-	+70	°C
Storage temperature range	V <sub>ST</sub>	-25	-	+75	

## 5.Interface pin description

Pin no.	Symbol	External connection	Function					
1	/CS	MPU	Used to enter chip select signal					
2	/RESET	MPU	Controller reset (module reset)					
3	A0	MPU	Register select signal					
4	R/W	MPU	Read/write select signal					
5	Е	MPU	Operation (data read/write) enable signal					
6~10	DB0~DB3	MPU	Four low order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCM. These four are not used during 4-bit operation.					
11~13	DB4~DB7	MPU	Four high order bi-directional three-state data bus lines. Used for data transfer between the MPU					
14	$V_{DD}$		Power supply for logic (+5V) for LCM					
15	Vss		Signal ground for LCM (GND)					
16	VOUT							
17	CAP3-	Power supply						
18	CAP1+	r ower supply	DC/DC valtage converter					
19	CAP1-		DC/DC voltage converter.					
20	CAP2-							
21	CAP+							
22	V1							
23	V2							
24	V3	Power for LCD	A multi-level power supply for the liquid crystal drive.					
25	V4							
26	V5							
27	VR		Output voltage regulator terminal.					
28	C86	MPU	This is the MPU interface switch terminal.					
29	PS	MPU	This is the parallel input/serial data input switch terminal.					
30	/IRS	MPU	This terminal selects the resistors for the V5 voltage level adjustment.					

## **6.Optical characteristics**

STN type display module (Ta=25°C, VDD=5.0V)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	
Viewing angle	θ	Cr≥2	-60	-	35	202	
	Ф	Ur≥2	-40	-	40	deg	
Contrast ratio	Cr		-	6	-	-	
Response time (rise)	Tr	-	-	150	250	me	
Response time (fall)	Tr	-	-	150	250	ms	

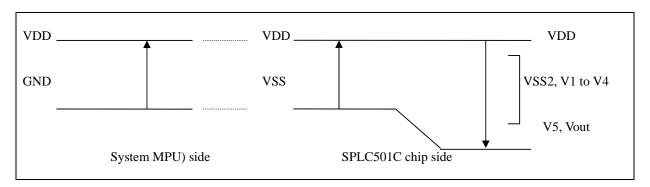
#### 7. Electrical characteristics

DC characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage for LCD	$V_{DD}$ - $V_0$	Ta =25°C	-	9.5	-	V
Input voltage	$V_{\text{DD}}$		4.7	5.0	5.5	
Supply current	I <sub>DD</sub>	Ta=25°C, V <sub>DD</sub> =5.0V	-	1.5	2.5	mA
Input leakage current	I <sub>LKG</sub>		-	-	1.0	uA
"H" level input voltage	VIH		2.2	-	$V_{DD}$	
"L" level input voltage	VIL	Twice initial value or less	0	-	0.6	
"H" level output voltage	Vон	LOH=-0.25mA	2.4	-	-	V
"L" level output voltage	Vol	LOH=1.6mA	-	-	0.4	
Backlight supply voltage	VF		-	3.0	-	
Backlight supply current	I <sub>LED</sub>	V <sub>F</sub> =3.2V	-	60	-	mA

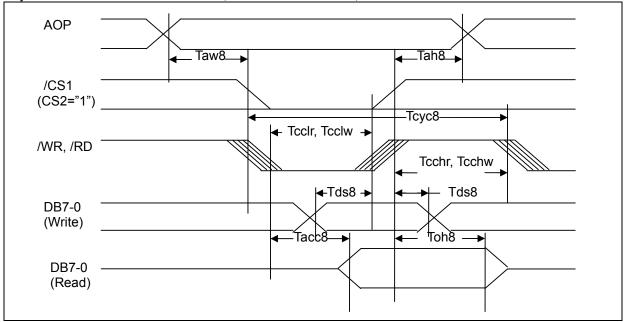
# **8. Absolute Maximum Ratings** (Unless otherwise noted, VSS=0V)

Parar	neter	Symbol	Conditions	Unit
Power Supply Voltage		VDD	-0.3 to +7.0	V
Power supply voltage (2)		VSS2	-7.0  to  +0.3	V
(VDD Standard)	With Triple step-up		-4.0 to $+0.3$	
	With Quad step-up		-3.0 to $+0.3$	
Power supply voltage (3) (V	Power supply voltage (3) (VDD standard)		-12.0 to +0.3	V
Power supply voltage (4) (V	/DD standard)	V1,V2,V3,V4	V5 to +0.3	V
Input Voltage		Vin	-0.3 to VDD+0.3	V
Output voltage		Vo	-0.3 to VDD+0.3	V
Operating Temp.		Topr	-40 to 85	С
Storage Temp.	Bare chip	Tstr	-55 to +125	С



### 9. Timing Characteristics

9.1 System bus read/write characteristics 1 (for the 8080 series MPU)



(VDD=4.5V to 5.5V, Ta=25C)

Y4	C:1	Crimb of	Constitution	Rating		Unit
Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address hold time	AOP	Tah8		0	-	ns
Address setup time		Taw8		0	-	ns
System cycle time	AOP	Tcyc8		166	-	ns
Control L pulse with (/WR)	/WR	Tcclw		30	-	ns
Control L pulse with (/RD)	/RD	Teelr		70	-	ns
Control H pulse with (/WR)	/WR	Techw		30	-	ns
Control H pulse with (/RD)	/RD	Techr		30	-	ns
Data setup time		Tds8		30	-	ns
Address hold time	DB7-0	Tdh8		10	-	ns
/RD access time	טבי/-0	Tacc8	C1-100pE	-	70	ns
Output disable time		Toh8	Cl=100pF	5.0	50	ns

(VDD=2.7V to 4.5V, Ta=25C)

Y4	C:1	Crimb of	Condition	Rating		TT*4
Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address hold time	AOP	Tah8		0	-	ns
Address setup time		Taw8		0	-	ns
System cycle time	AOP	Tcyc8		300	-	ns
Control L pulse with (/WR)	/WR	Tcclw		60	-	ns
Control L pulse with (/RD)	/RD	Tcclr		120	-	ns
Control H pulse with (/WR)	/WR	Techw		60	-	ns
Control H pulse with (/RD)	/RD	Techr		60	-	ns
Data setup time		Tds8		40	-	ns
Address hold time	DB7-0	Tdh8		15	-	ns
/RD access time	טבי/-0	Tacc8	C1-100pE	-	140	ns
Output disable time		Toh8	Cl=100pF	10	100	ns

(VDD=2.4V to 2.7V, Ta=25C)

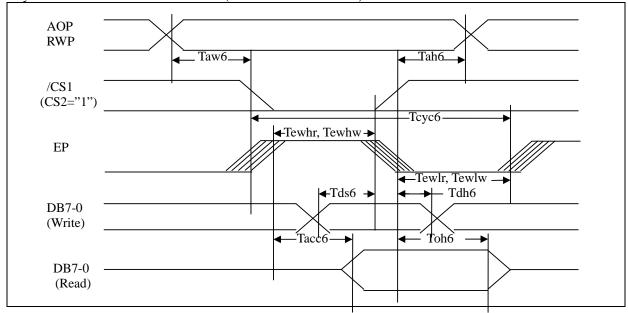
Item	Cional	Cromb ol	Condition	Rating		Unit
nem	Signal	Symbol	Condition	Min.	Max.	Unit
Address hold time	AOP	Tah8		0	-	ns
Address setup time		Taw8		0	-	ns
System cycle time	AOP	Tcyc8		1000	-	ns
Control L pulse with (/WR)	/WR	Tcclw		120	-	ns
Control L pulse with (/RD)	/RD	Tcclr		240	-	ns
Control H pulse with (/WR)	/WR	Techw		120	-	ns
Control H pulse with (/RD)	/RD	Techr		120	-	ns
Data setup time		Tds8		80	-	ns
Address hold time	DB7-0	Tdh8		30	-	ns
/RD access time	טבי/-0	Tacc8	C1-100pE	-	280	ns
Output disable time		Toh8	Cl=100pF	10	200	ns

Note1: The input signal rise time and fall time(Tr, Tf) is specified at 15 ns or less. When the system cycle time is extremely fast, (Tr-Tf) < or = (Tcyc8-Tcclw-Tcchw) for (Tr+Tf) < or = (Tcyc8-Tcclr-Tcchr) are specified.

Note2: All timing is specified using 20% and 80% of VDD as the reference.

Note3: Tcclw and Tcclr are specified as the overlap between /CS1 being "L" (/CS2 = "H") and /WR and /RD being at the "L' level.

9.2 System bus read/write characteristics 1 (for the 6800 series MPU)



(VDD=4.5V to 5.5V, Ta=25C)

The me	C:1	anal Symbol Conditi		Rating		T I :4	
Item		Signal	Symbol	Condition	Min.	Max.	Unit
Address hold time		AOP	Tah6		0	-	ns
Address setup time			Taw6		0	-	ns
System cycle time		AOP	Tcyc6		166	-	ns
Data setup time	Data setup time		Tds6	C1 100-E	30	-	ns
Data hold time		DB7-0	Tdh6	Cl=100pF	10	-	ns
Access time	Access time		Tacc6		-	70	ns
Output disable time			Toh6		10	50	ns
Enable H pulse time	Read	EP	Tewhr		70	-	ns
Eliable H pulse tillle	Write	Er	Tewhw		30	-	ns
Enable I pulse time	Read	EP	Tewlr		30	-	ns
Enable L pulse time	Write	EP	Tewlw		30	-	ns

(VDD=2.7V to 4.5V, Ta=25C)

Itam	Cional	Crimb of	Condition	Rat	T I :4		
Item		Signal	Symbol	Condition	Min.	Max.	Unit
Address hold time		AOP	Tah6		0	-	ns
Address setup time			Taw6		0	-	ns
System cycle time		AOP	Tcyc6		300	-	ns
Data setup time	Data setup time		Tds6	CL 100 E	40	-	ns
Data hold time		DB7-0	Tdh6	Cl=100pF	15	-	ns
Access time	Access time		Tacc6		-	140	ns
Output disable time			Toh6		10	100	ns
Emphia II mulaa tima	Read	EP	Tewhr		120	-	ns
Enable H pulse time Write		EP	Tewhw		60	-	ns
Enoble Laules time Read		EP	Tewlr		60	-	ns
Enable L pulse time	Write	EP	Tewlw		60	-	ns

(VDD=2.4V to 2.7V, Ta=25C)

T4	C:1	C11	Condition	Rat	TT. 14		
Item		Signal	Symbol	Condition	Min.	Max.	Unit
Address hold time		AOP	Tah6		0	-	ns
Address setup time			Taw6		0	-	ns
System cycle time		AOP	Tcyc6		1000	-	ns
Data setup time	Data setup time		Tds6	C1_100mE	80	-	ns
Data hold time	Data hold time			Cl=100pF	30	-	ns
Access time	Access time		Tacc6		-	280	ns
Output disable time	Output disable time		Toh6		10	120	ns
Enoble II nulse time	Read	EP	Tewhr		240	-	ns
Enable H pulse time	Write	EP	Tewhw		120	-	ns
Enable I pulse time	Read	EP	Tewlr		120	-	ns
Enable L pulse time	Write	EP	Tewlw		120	-	ns

Note1: The input signal rise time and fall time (Tr, Tf) is specified at ns or less. When the system cycle time is extremely fast, (Tr+Tf) < or = (Tcyc6-Tewlw-Tewhw) for (Tr+Tf) < or = (Tcyc6-Tewlr-Tewhr) are specified.

Note2: All timing is specified using 20% and 80% of VDD as the reference.

Note3: Tewlw and Tewlr are specified as the overlap between /CS1 being "L" (CS2="H") and EP.

## 10. Table of LCM commands

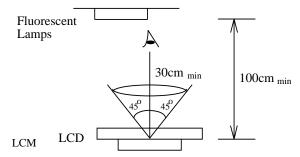
Display ON/OFF		••••											
Display ON/OFF	Command	Com											Function
Display start line set											DB1		
	1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1		0: OFF, 1: ON
4   Column address set   0	2) Display start line set	0	1	0	0	1	Dis	play	start a	addres	SS		Set the display RAM display start line address
Uniform of the column address set	3) Page address set	0	1	0	1	0	1	1	Pag	e add	ress		Sets the display RAM page address
Lower bit   Signar read		0	1	0	0	0	0	1					Sets the most significant 4 bits of the display RAM column address
Display data write		0	1	0	0	0	0	0					Sets the least significant 4 bits of the display RAM column address
7) Display data read	5) Status read	0	0	1		Statu	s		0	0	0	0	Reads the status data
8) ADC select		1	1	0				Wri	te da	ta			Writes the status RAM
Output correspondence			0					Rea	ıd dat	a			
10   Display all points	8) ADC select	0	1	0	1	0	1	0	0	0	0		
ON/OFF	9) Display normal/reverse	0	1	0	1	0	1	0	0	1	1		normal/reverse
11) LCD bias set		0	1	0	1	0	1	0	0	1	0		0: normal display
12) Read/modify/write	11) LCD bias set	0	1	0	1	0	1	0	0	0	1		Sets the LCD driver voltage bias ratio SPLC501C0: 1/9, 1: 1/7
14) Reset	12) Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	At write: +1
15) Common output mode select	13) End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write
1	14) Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset
17) V5 voltage regulator internal resistor ratio set		0	1	0	1	1	0	0		*	*	*	
Internal resistor ratio set	16) Power control set	0	1	0	0	0	1	0	1	Opera	ting	mode	1 11 5
Mode set   Electronic volume register set	internal resistor ratio	0	1	0	0	0	1	0	0	Resis	tor ra	tio	Select internal resistor ratio (Rb/Ra) mode
Electronic volume register set		0	1	0	1	0	0	0	0	0	0	1	Set the V5 output voltage electronic volume register
AOP   AOP		0	1	0	*	*	Ele	ctron	ic vol	lume	value		
AOP   AOP	Command	Com	mand	Code									Function
1					DB7 I	DB6 I	DB5	DB4	DB3	DB2	DB1	DB0	
Static indicator Register set			,	, ,,,								0	0: OFF, 1: ON
20) Page Blink	Static indicator				*	*	*	*	*	*	Mo		Set the flashing mode
Page selection         0         1         0         P7         P6         P5         P4         P3         P2         P1         P0         P7-0: 1 – blinking page 0 – no blinking, normal d           21) Driving Mode set Mode selection         0         1         0         1         1         0         1         0		0	1	0	1	1	0	1	0	1	0	1	
Mode selection         0         1         0         D1         D0         0         0         0         0         Driving capability (D1, D0): (1,1)>(0,0)>(0,1)>(1,0)           22) Power saver    Display OFF and display all	Page selection	0		0	P7	P6		P4			P1		0 – no blinking, normal display
7/1 Power saver													Driving capability (D1, D0): (1,1)>(0,0)>(0,1)>(1,0)
ON compound command	22) Power saver												Display OFF and display all points ON compound command
6) Display data write 0 1 0 1 1 1 0 0 0 1 1 Command for non-operation	6) Display data write	0	1	0	1	1	1	0		0	1	1	
7) Display data read 0 1 0 1 1 1 1 1 * * * * * * Command for IC test. Do not this command	7) Display data read	0	1	0									Command for IC test. Do not use this command

#### 11.QUALITY SPECIFICATIONS

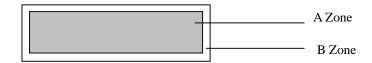
#### 11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area).

B Zone: Non-active display area (outside viewing area).

# 11.2 Specification of quality assurance AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification (Note: \* is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
	Polarizer	Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

#### Note on defect classification

No.	Item	Criterion						
1	Short or open circuit	Not allow						
	LC leakage							
	Flickering							
	No display							
	Wrong viewing direction							
	Wrong Back-light							
2	Contrast defect		Ref	er to approva	ıl sample			
	Background color deviation							
3	Point defect, Black spot, dust	Ç		Point Size	Acceptable Qty.			
	(including Polarizer)	$\mathbf{X}^{T}$		φ <u>&lt;</u> 0.10	Disregard 3			
				0.10<φ≤0.20				
	$\phi = (X+Y)/2$			0.20<φ≤0.25	2			
				0.25<φ≤0.30	loit : mm			
				ф>0.30	Jhit: mm <sub>0</sub>			
4	Line defect,	<u> </u>						
	Scratch	w		Line	Acceptable Qty.			
	Sciator	$\left  \stackrel{ \longleftrightarrow }{\longleftrightarrow} \right $	L	W 0.015≥W	Disregard			
			3.0≥L	0.03≥W				
			2.0≥L	0.05≥W	2			
			1.0≥L	0.1 > W	1			
				0.05 <w< td=""><td>Applied as point defect</td><td></td></w<>	Applied as point defect			
		Unit: mm						
5	Rainbow	Not more than two color changes across the viewing area.						

No	Item	Criterion
6	Chip  Remark: X: Length direction Y: Short direction	Acceptable criterion $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
	Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
		Acceptable criterion $ \begin{array}{c ccccc} X & Y & Z \\                                  $
		Acceptable criterion $\begin{array}{c ccccccccccccccccccccccccccccccccccc$
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

No.	Item	Criterion						
7	Segment pattern W = Segment width φ = (X+Y)/2	(1) Pin hole  φ < 0.10mm is acceptable.						
		Y Point Size Acceptable Qty    o						
		1/4W< φ≤1/2W 1						
		$\phi > 1/2W$						
8	Back-light	(1) The color of backlight should correspond its specification.						
		(2) Not allow flickering						
9	Soldering	(1) Not allow heavy dirty and solder ball on PCB.						
		(The size of dirty refer to point and dust defect)						
		(2) Over 50% of lead should be soldered on Land.						
		Land						
		50% lead						
10	Wire	(1) Copper wire should not be rusted						
		(2) Not allow crack on copper wire connection.						
		(3) Not allow reversing the position of the flat cable.						
		(4) Not allow exposed copper wire inside the flat cable.						
11*	PCB	(1) Not allow screw rust or damage.						
		(2) Not allow missing or wrong putting of component.						

No	Item	Criterion
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$
13	TAB	1. Position  W W1≤1/3W H1≤1/3H  2 TAB bonding strength test  TAB  P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min)
14	Total no of acceptable	5pcs per SOA (shipment)
14	Total no. of acceptable  Defect	A. Zone  Maximum 2 minor non-conformities per one unit.  Defect distance: each point to be separated over 10mm  B. Zone  It is acceptable when it is no trouble for quality and assembly in customer's end product.

#### 11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	NI a alama mana liki a a
Low temp. Storage	-30°C	48	No abnormalities in functions
Low temp. Operating	-20°C	48	and appearance
Humidity	40°C/ 90%RH	48	
Temp. Cycle	$0^{\circ}$ C ← $25^{\circ}$ C → $50^{\circ}$ C (30 min ← 5 min → 30min)	10cycles	

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (20±8°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

#### 11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

#### **General Precautions:**

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting Newhaven
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

#### **Static Electricity Precautions:**

- CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and

the interface terminals with any parts of the human body.

- Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

#### **Soldering Precautions:**

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

#### **Operation Precautions:**

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

#### **Limited Warranty**

Newhaven LCDs and modules are not consumer products, but may be incorporated by Newhaven's customers into consumer products or components thereof, Newhaven does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of Newhaven is limited to repair or replacement on the terms set forth below. Newhaven will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Newhaven and the customer, Newhaven will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Newhaven general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.